

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

T6F19, JT6F19-AS

T6F19, JT6F19-AS CMOS Single-Chip LSI for LCD Calculator

The T6F19, JT6F19-AS is a CMOS single-chip microcomputer for 12-digit capacity 1-memory calculation.

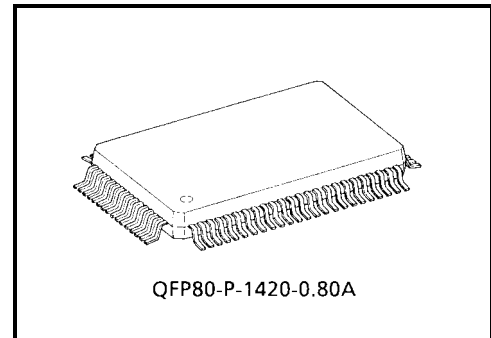
T6F19, JT6F19-AS is the complete single chip CMOS LSI for calculator with single power supply operation.

Wide operating voltage range and low power consumption make it suitable for 1.5 V solar battery operated.

Besides T6F19, JT6F19-AS can be selectable with a pin-programmable to function of Power timer and Memory hold. With the following features.

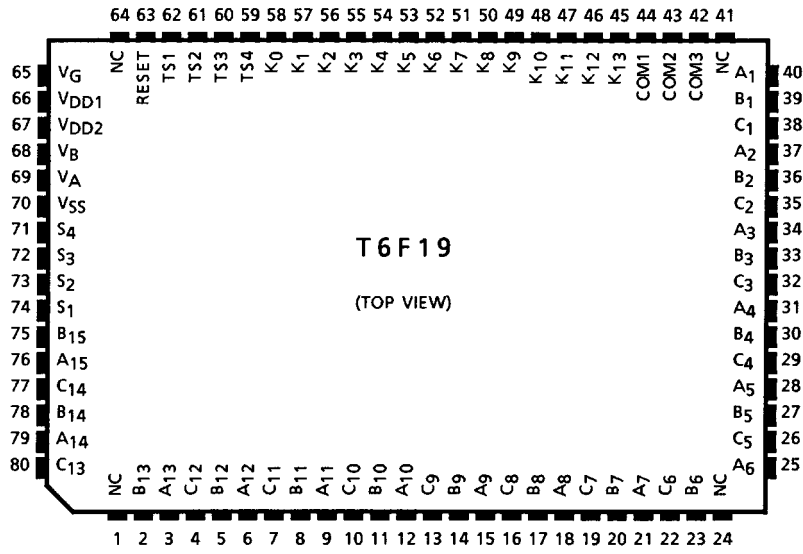
Features

- Display: 12 digits (selectable with a pin-programmable) of data, 2 digits of sign, error symbol, memory load symbol.
- Algebraic mode.
- Standard 4 functions (+, -, ×, ÷)
- Rate conversion calculation
- Automatic percentage operation with add-on, discount.
- Automatic delta percentage, mark-up and markdown operations.
- Square root.
- Constant calculation.
- Chain calculation.
- Change sign.
- Floating point or momentary mode (selectable with a switch).
- Fixed point ("0", "1", "2", "3", "4" or "6" places) or floating point (selectable with a switch).
- Adding point mode (selectable with a switch).
- Rounding switches (rounding up, down and off).
- Leading zero suppression.
- Trailing zero suppression.
- Punctuation on display, commas for thousands.
- Memory contents indicator, turned on with non-zero in the memory.
- Registration overflow, indicating that too many digits are entered (the most significant digit are protected).
- Result overflow, indicating during calculation (most function key are locked as it happened).
- Memory overflow indicating to flashing of memory load mark.
- Key roll over function.
- Floating minus.



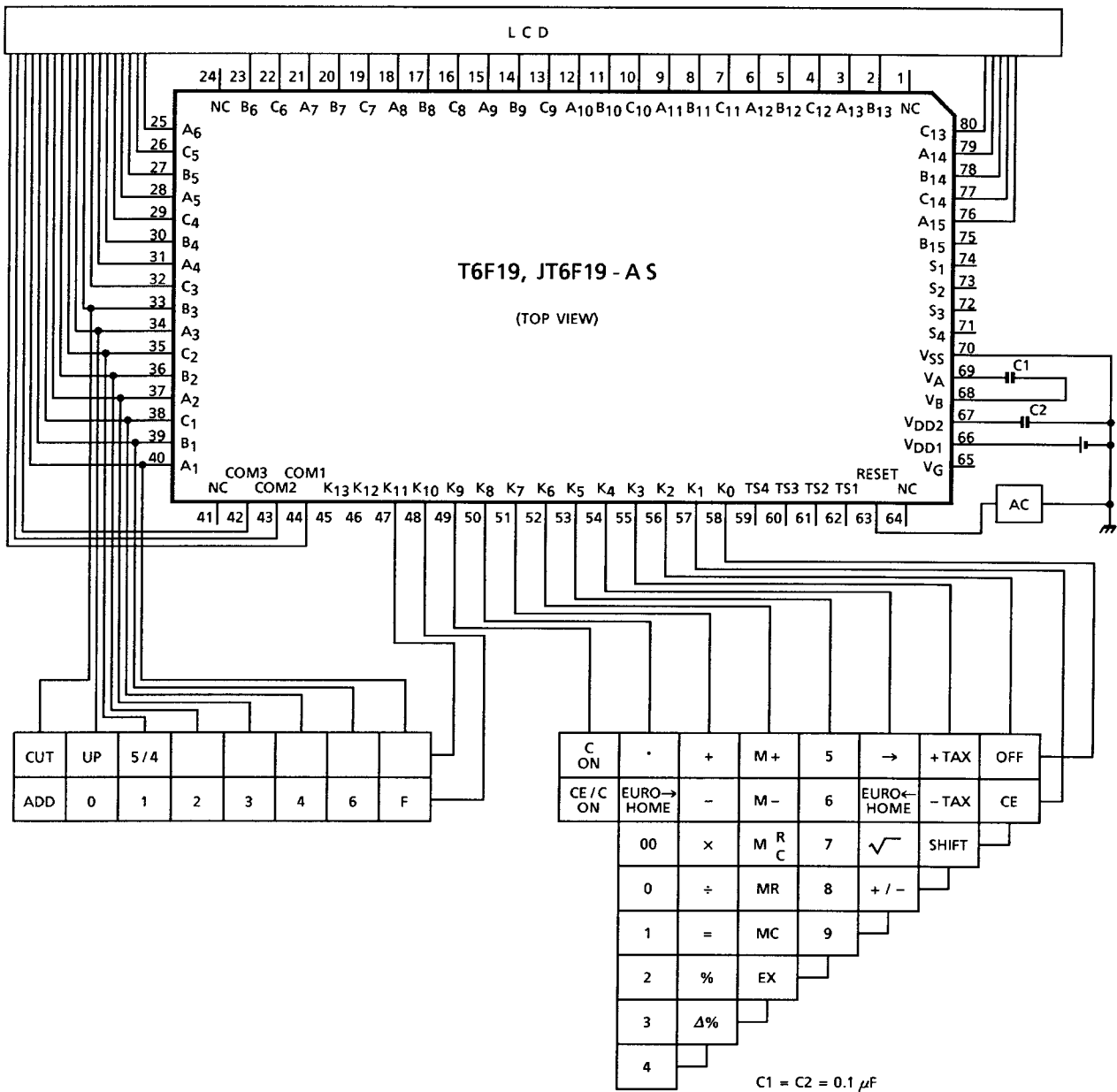
Weight: 1.52 g (typ.)

Pin Assignment (top view)

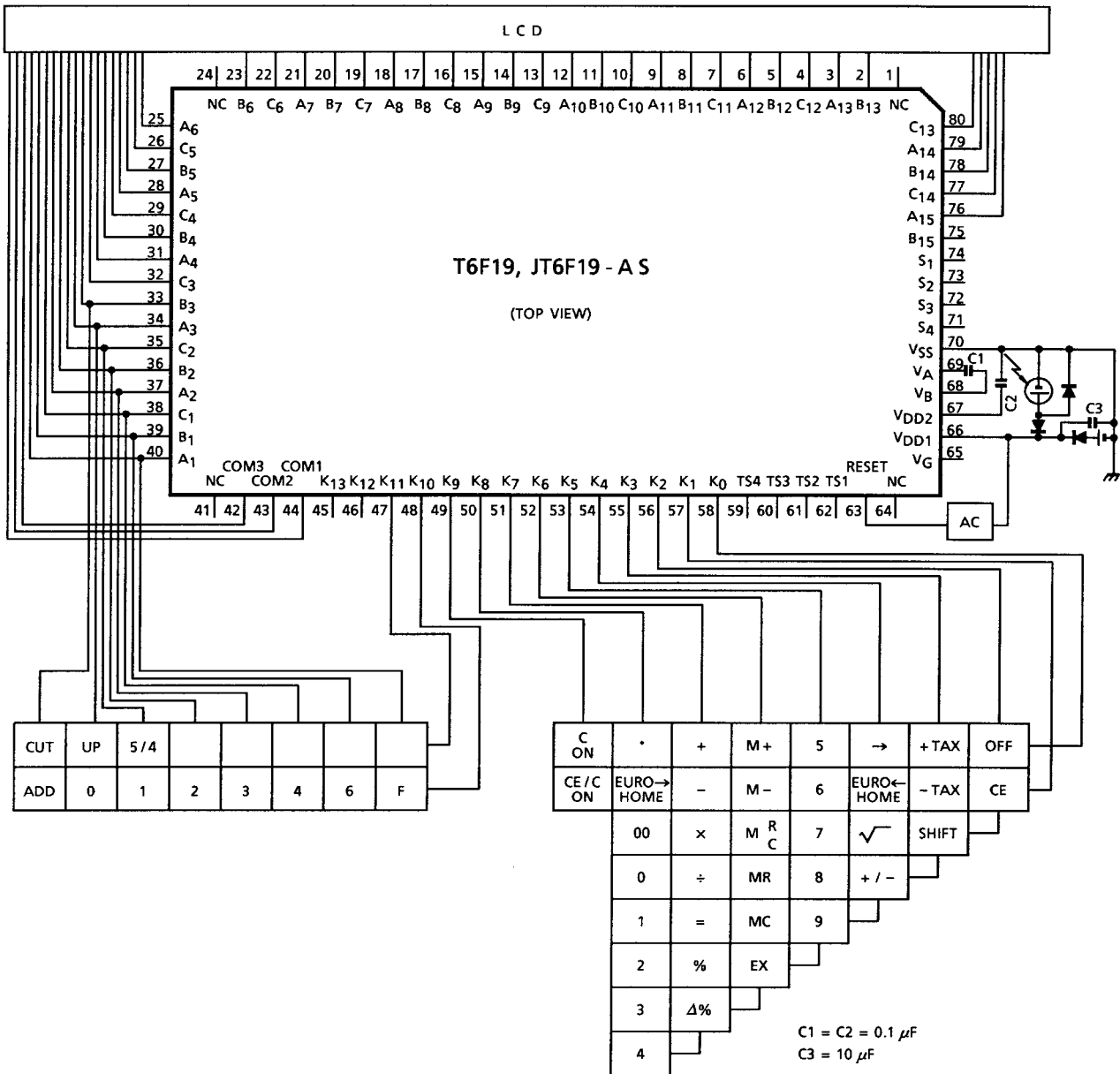


System Block Diagram

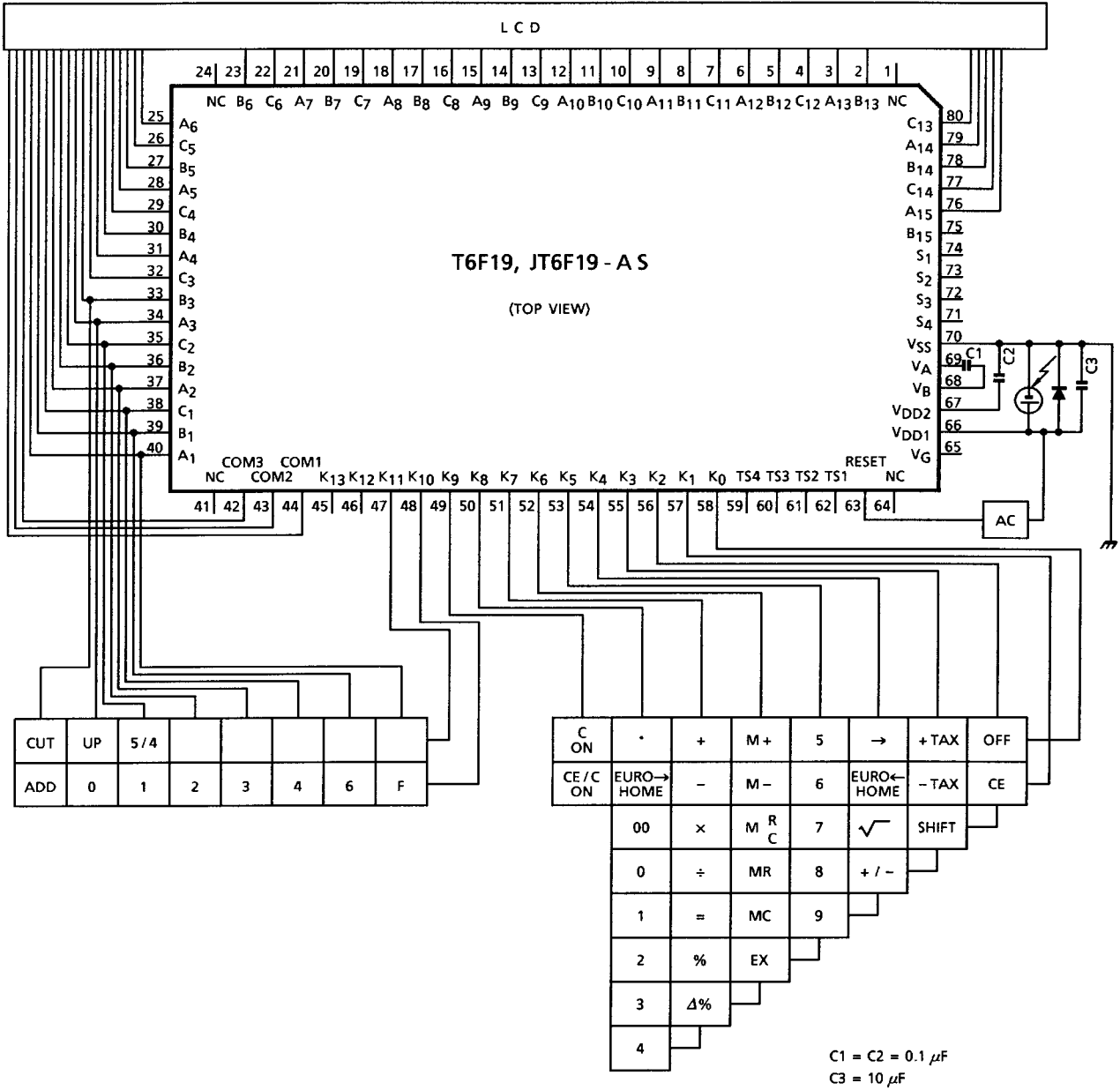
Battery Type



Dual Type

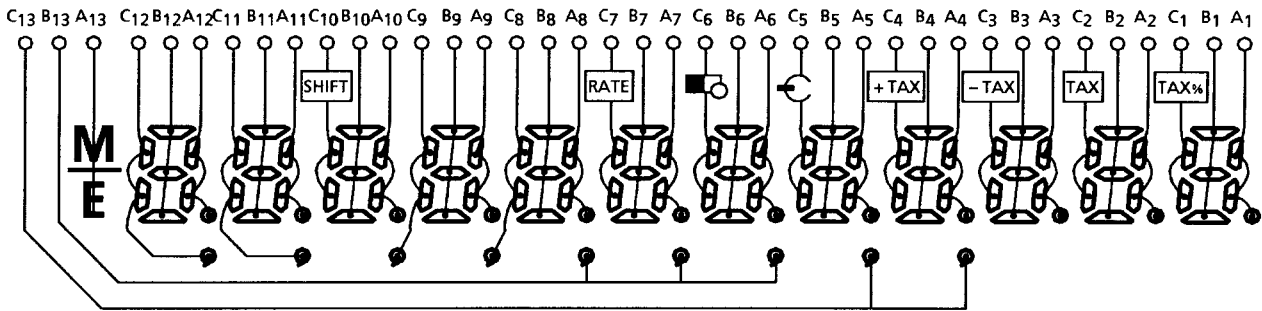


Solar Type

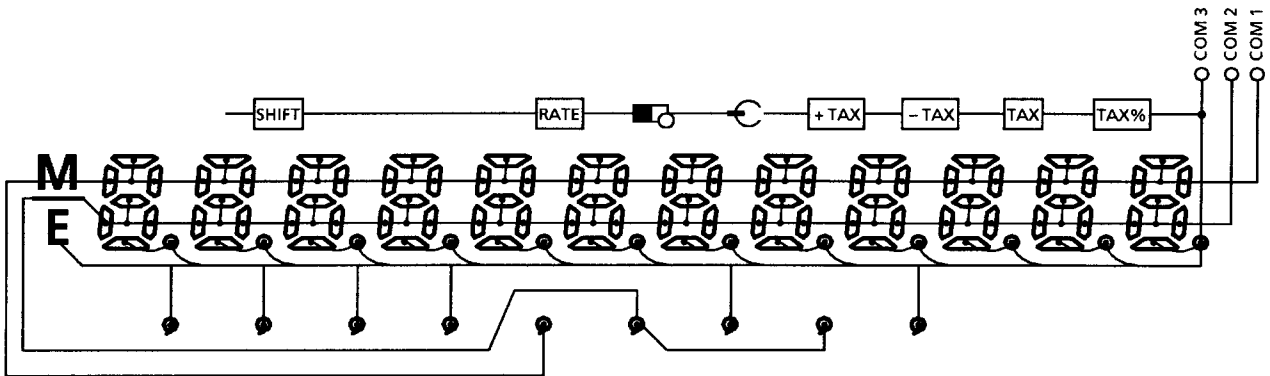


Connection of LCD

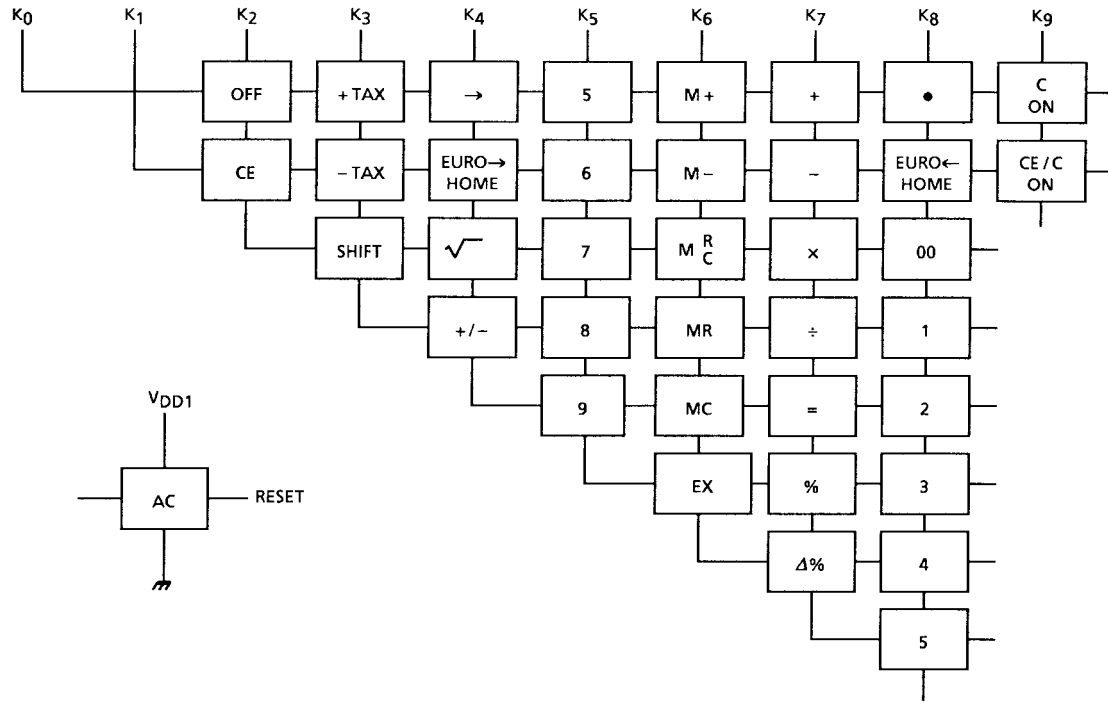
Segment



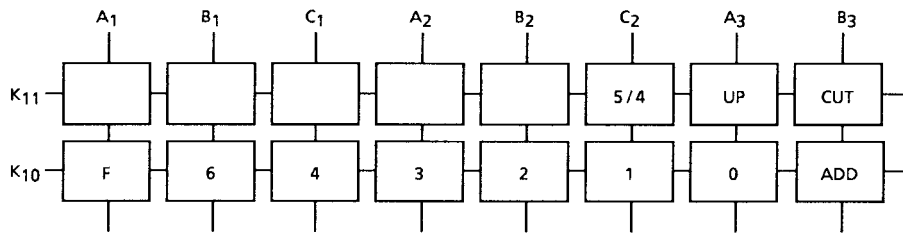
Common



Key Connection



Touch Key



Lock Key

K11: Rounding switches.

K10: Selectable with fixed point or floating mode.

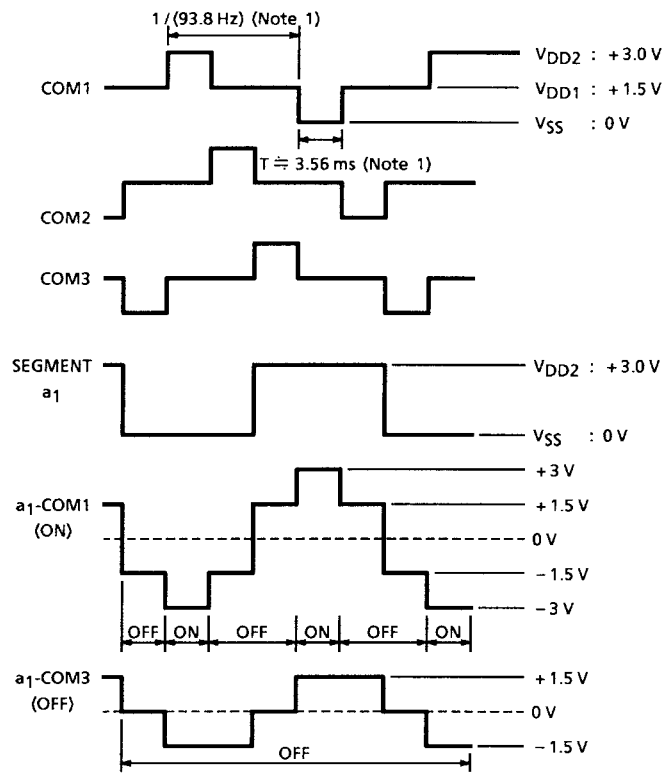
Maximum Ratings

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{DD1}	-0.3~2.0	V
Input voltage	V_{IN}	-0.3~ $V_{DD1} + 0.3$	V
Operating temperature	T_{opr}	0~40	°C
Storage temperature	T_{stg}	-55~125	°C

Electrical Characteristics ($V_{DD1} = 1.5 \pm 0.2$ V, $V_{DD2} = 3.0 \pm 0.4$ V, $V_{SS} = 0$ V, $T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Circuit	Pin Name	Test Condition	Min	Typ.	Max	Unit	
Operating voltage	V_{DD1}	—	—	—	1.2	1.5	2.0	V	
"1" input voltage	V_{IH} (1)	—	K ₂ ~K ₉ RESET	—	$V_{DD1} - 0.4$	—	V_{DD1}	V	
"1" input voltage	V_{IH} (2)	—	K ₁₀ ~K ₁₃	—	$V_{DD2} - 0.4$	—	V_{DD2}	V	
"0" input voltage	V_{IL}	—	K ₂ ~K ₁₃ RESET	—	0	—	0.4	V	
"1" output voltage	V_{OH} (1)	—	SEGMENT COM1~3	—	$V_{DD2} - 0.2$	—	V_{DD2}	V	
"0" output voltage	V_{OL} (1)	—	SEGMENT COM1~3	—	0	—	0.2	V	
"M" output voltage	V_{OM}	—	COM1~3	—	$V_{DD1} - 0.2$	—	$V_{DD1} + 0.2$	V	
"1" output voltage	V_{OH} (2)	—	K ₁ ~K ₉	—	$V_{DD1} - 0.2$	—	V_{DD1}	V	
"0" output voltage	V_{OL} (2)	—	K ₁ ~K ₁₃	—	0	—	0.2	V	
"1" output resistance	R_{OH}	—	SEGMENT COM1~3	$V_{OUT} = V_{DD2} - 0.5$ V	—	—	70	k Ω	
"0" output resistance	R_{OL}	—	SEGMENT COM1~3	$V_{OUT} = 0.5$ V	—	—	70	k Ω	
Key pull up resistance	R_{KEYH} (1)	—	RESET	$V_{OUT} = V_{DD1} - 0.5$ V	—	—	25	k Ω	
	R_{KEYH} (2)	—	K ₀ ~K ₉	$V_{OUT} = V_{DD1} - 0.5$ V	—	—	14		
	R_{KEYH} (3)	—	K ₁₀ ~K ₁₃	$V_{OUT} = 0$ V	120	—	800		
Key pull down resistance	R_{KEYL} (1)	—	RESET (1)	$V_{OUT} = V_{DD1}$	100	—	300	k Ω	
	R_{KEYL} (2)	—	RESET (2)	$V_{OUT} = V_{DD1}$	18	—	300		
	R_{KEYL} (3)	—	K ₀ ~K ₉ (1)	$V_{OUT} = 0.5$ V	—	—	50		
	R_{KEYL} (4)	—	K ₀ ~K ₉ (2)	$V_{OUT} = V_{DD1}$	72	—	170		
Oscillating (WAIT)	f_{ϕ} WAIT	—	—	$V_{DD1} = 1.5$ V	5.4	9.0	15.5	kHz	
Frequency (OPERATE)	f_{ϕ} OP	—	—	$V_{DD1} = 1.5$ V	20.0	34	61.3	kHz	
Frame frequency	f_F	—	SEGMENT COM1~3	$V_{DD1} = 1.5$ V	56.3	93.8	161.5	Hz	
Supply current	1 (WAIT)	I_{DD} WAIT	—	—	$V_{DD1} = 1.5$ V	—	—	3.3	μ A
	2 (OPERATE)	I_{DD} OP	—	—	$V_{DD1} = 1.2$ V	—	—	8.9	
	3 (OFF)	I_{DD} OFF	—	—	$V_{DD1} = 1.5$ V	—	—	2.0	
Power off timer times	T	—	—	$V_{DD1} = 1.5$ V	429	600	1001	s	

Waveforms for Display



Note 1: at $f\phi = 9 \text{ kHz}$

Pad Location Table

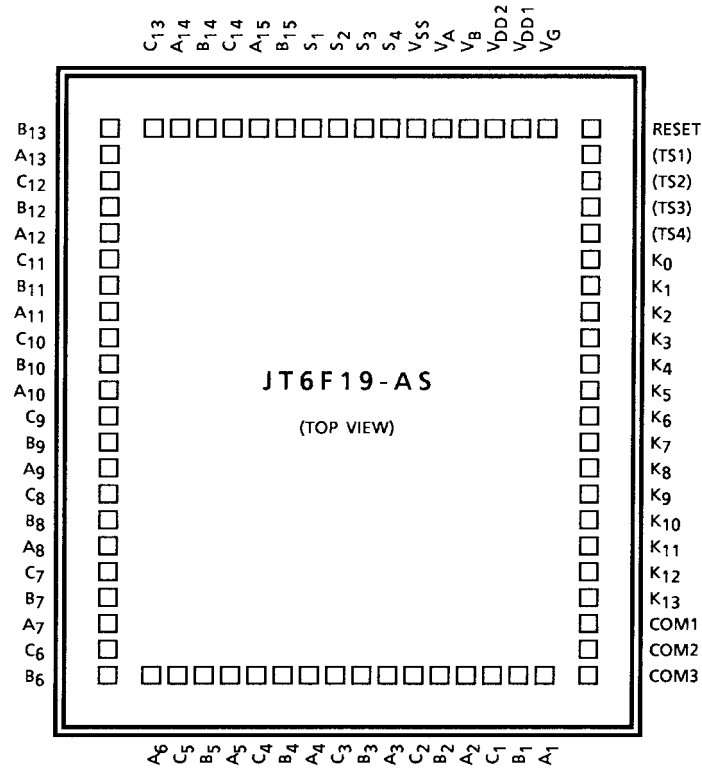
(μm)

Name	X Point	Y Point
B ₆	-1757	-1680
C ₆	-1757	-1520
A ₇	-1757	-1360
B ₇	-1757	-1200
C ₇	-1757	-1040
A ₈	-1757	-880
B ₈	-1757	-720
C ₈	-1757	-560
A ₉	-1757	-400
B ₉	-1757	-240
C ₉	-1757	-80
A ₁₀	-1757	80
B ₁₀	-1757	240
C ₁₀	-1757	400
A ₁₁	-1757	560
B ₁₁	-1757	720
C ₁₁	-1757	880
A ₁₂	-1757	1040
B ₁₂	-1757	1200
C ₁₂	-1757	1360
A ₁₃	-1757	1520
B ₁₃	-1757	1680
C ₁₃	-1089	1753
A ₁₄	-929	1753
B ₁₄	-769	1753
C ₁₄	-609	1753
A ₁₅	-449	1753
B ₁₅	-289	1753
S ₁	-129	1753
S ₂	31	1753
S ₃	191	1753
S ₄	351	1753
V _{SS}	511	1753
V _A	671	1753
V _B	831	1753
V _{DD2}	991	1753
V _{DD1}	1151	1753
V _G	1388	1753

Name	X Point	Y Point
RESET	1757	1680
(TS1)	1757	1520
(TS2)	1757	1360
(TS3)	1757	1200
(TS4)	1757	1040
K ₀	1757	880
K ₁	1757	720
K ₂	1757	560
K ₃	1757	400
K ₄	1757	240
K ₅	1757	80
K ₆	1757	-80
K ₇	1757	-240
K ₈	1757	-400
K ₉	1757	-560
K ₁₀	1757	-720
K ₁₁	1757	-880
K ₁₂	1757	-1040
K ₁₃	1757	-1200
COM1	1757	-1360
COM2	1757	-1520
COM3	1757	-1680
A ₁	1122	-1752
B ₁	962	-1752
C ₁	802	-1752
A ₂	642	-1752
B ₂	482	-1752
C ₂	322	-1752
A ₃	162	-1752
B ₃	2	-1752
C ₃	-158	-1752
A ₄	-318	-1752
B ₄	-478	-1752
C ₄	-638	-1752
A ₅	-798	-1752
B ₅	-958	-1752
C ₅	-1118	-1752
A ₆	-1278	-1752

Note 2: () Do not connect.

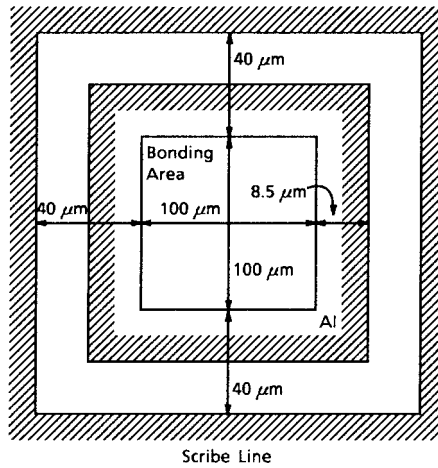
Chip Layout



Chip size : 3.79 × 3.84 (mm)
 Chip thickness : 440 ± 30 (μm)
 Substrate : V_{SS}

Pad Layout

Active Element

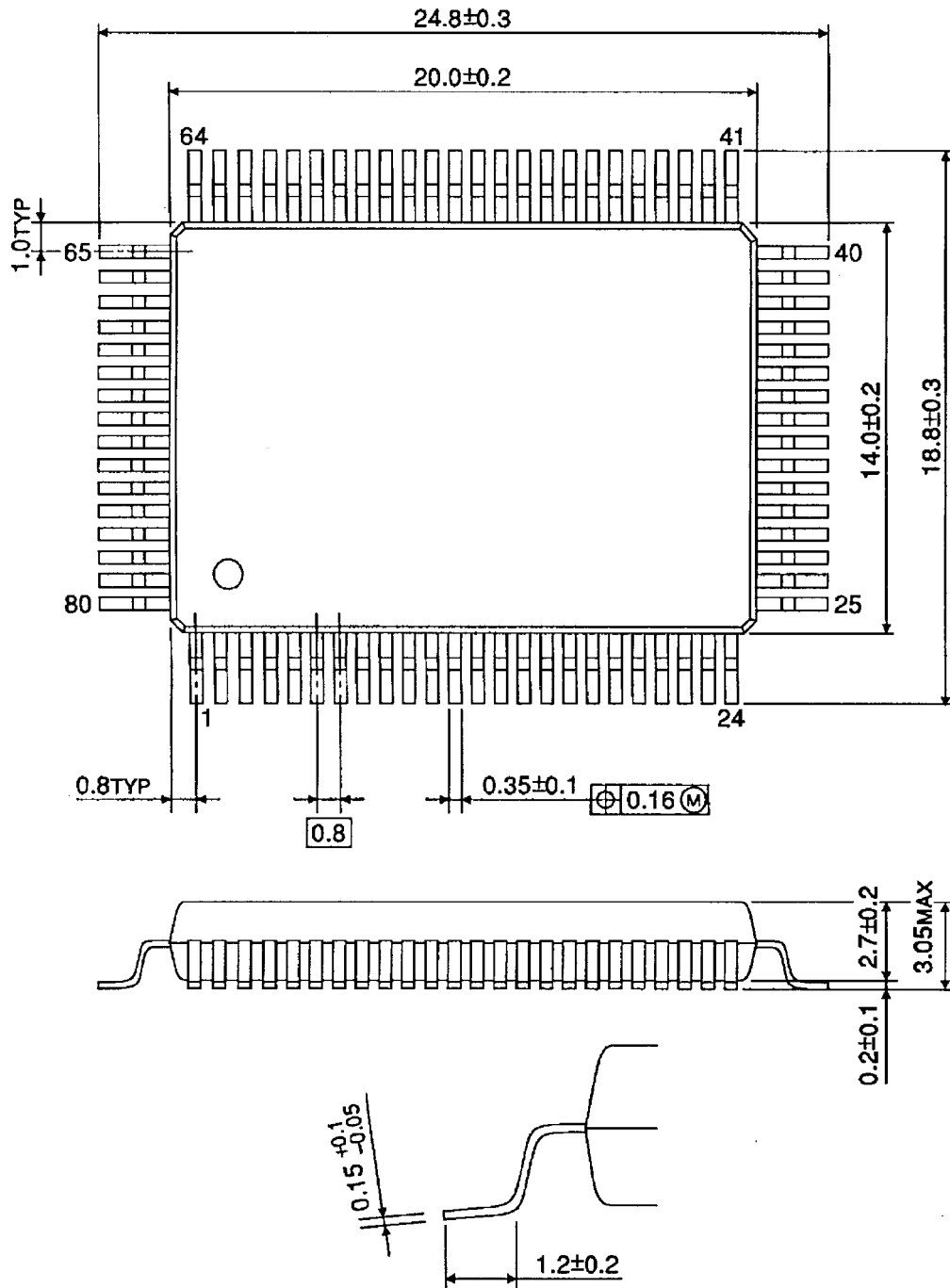


PAD Pitch 160 μm

Package Dimensions

QFP80-P-1420-0.80A

Unit : mm



Weight: 1.52 g (typ.)

RESTRICTIONS ON PRODUCT USE

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